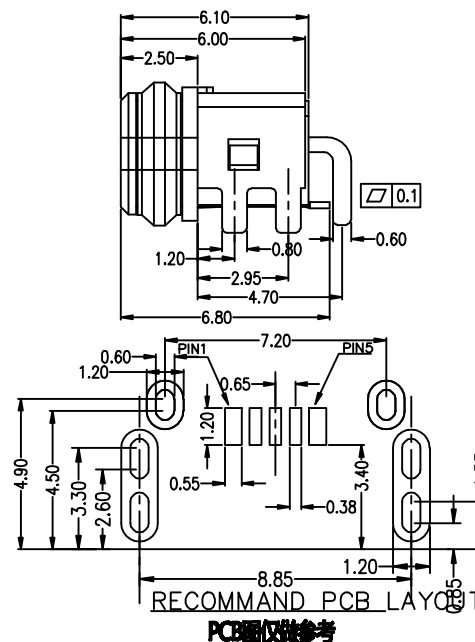
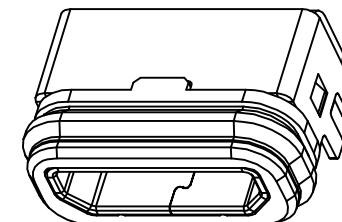
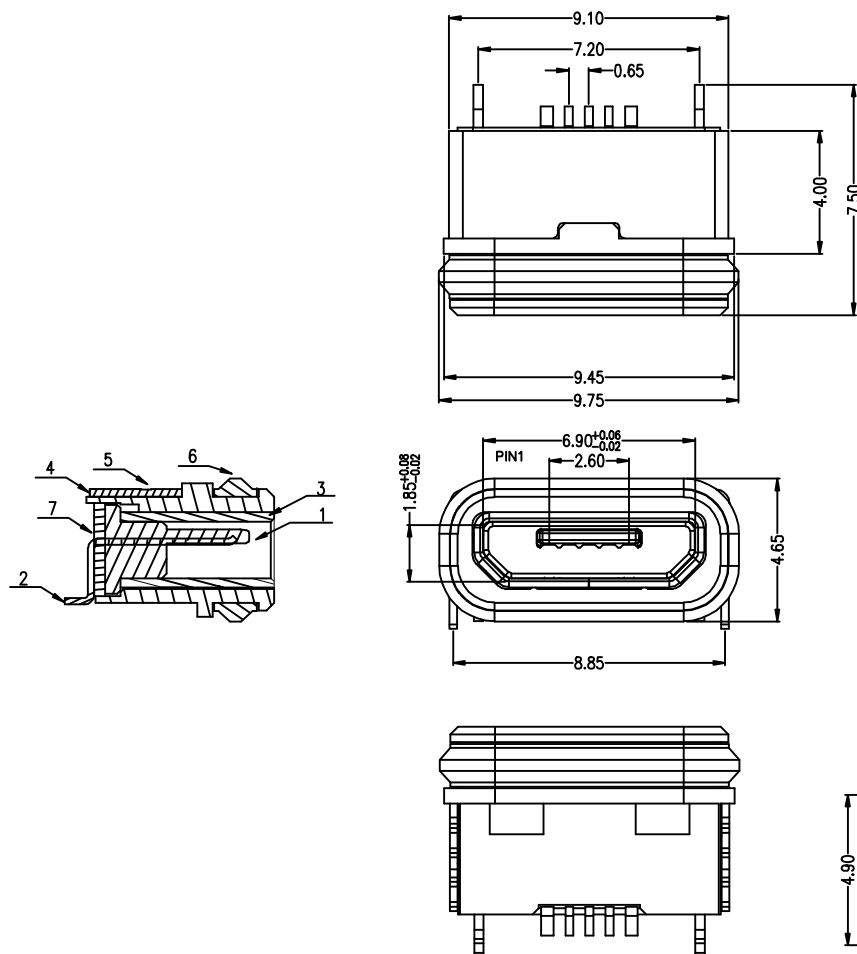


7	8	9	10
MAPX	MODIFICATION		DATE



Note:

1. Material:

- 1.1 Housing: High temperature thermoplastic
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: SUS304,t=0.30mm
- 1.4 cover: High temperature thermoplastic
- 1.5 out Shell: SUS304 T=0.25
- 1.6 Ring: SILICON
- 1.7 Epoxy: Epoxy

2.Specification:

- 2.1 Current rating:1,5PIN 2.0A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding
voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C
- 2.8 Waterproof: IPX68.

产品图 PRODUCT CHART DWG			深圳市精拓金电子有限公司							
公差一览表 TOLERANCE UNLESS OTHERWISE			单位 UNITS 比例 SCALE 日期 DATE	MM 1:1 2019. 11. 23	制图 DRAWING 审核 CHECK 核准 APPRO	YANG 郭志富 黄国荣	制图料号 PRODUCT PART NO. 产品名称 PRODUCT NO. MICRO SPIN 磁粉水1.1寸非接触式磁头	920-A64A2021S101A1		版本 VER AO
X.	±0.30 X.	±5.°								
.X	±0.25 .X	±2.°								
.XX	±0.15 .XX	±1.°								
.XXX	±0.10 .XXX	±0.5°								